

650V Super-junction Power MOSFET

Description

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Super-junction power MOSFET is a revolutionary technology for high voltage power MOSFETs, designed according to the SJ principle. The deep trench SJ MOSFET provide an extremely low switching, communication and conduction losses device with highest robustness make especially resonant switching applications more reliable, more efficient, lighter and cooler, designed by Wuxi Unigroup Microelectronics Company.

Features		Applications			
 Very low FOM R_{DS(on)}×Q_g 			wer Supply (SMPS)		
• 100% avalanche tested		Uninterruptible Power Supply (UPS)			
 Easy to use/drive 		 Power Factor Co 	prrection (PFC)		
RoHS compliant		Charger			
TO-252		Drain			
Gate Gate Source					
Device Marking and Pa	ckage Information				
Device	Package		Marking		
TPD65R750D	TO-252		65R750D		
Key Performance Para	ameters		•		
Parameter	Value		Unit		
V _{DS} @ T _{j,max}	700		V		
R _{DS(on),max}	0.75		Ω		
Q _{g,typ}	9.09		nC		
I _D	5		A		
I _{D,pulse}	15		А		
E _{OSS} @ 400V	1.04		μJ		



Absolute Maximum Ratings $T_c = 25^{\circ}C$, unless otherwise noted						
Parameter			Symbol	Values	Unit	
Continuous Drain Current	T _C = 25°C		1	5	•	
	T _C = 100°C		Ι _D	3	A	
Pulsed Drain Current		(note1)	I _{D,pulse}	15	А	
Gate-Source Voltage			V _{GSS}	±30V	V	
Single Pulse Avalanche Energy		(note2)	E _{AS}	20	mJ	
Repetitive Avalanche Energy		(note2)	E _{AR}	0.14	mJ	
Avalanche Current		I _{AR}	0.9	А		
MOSFET dv/dt Ruggedness, V _{DS} = 0480V		dv/dt	50	V/ns		
Power Dissipation For TO-252			P _D	46	W	
Continuous Diode Forward Current			I _S	5		
Diode Pulsed Current		(note1)	I _{S,pulse}	15	- A	
Reverse Diode dv/dt (r		(note3)	dv/dt	15	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55~+150	°C	

Thermal Resistance For TO-252					
Parameter	Symbol	Value	Unit		
Thermal Resistance, Junction-to-Case	R _{thJC} 2.72		°C/W		
Thermal Resistance, Junction-to-Ambient	R _{thJA}	62	0/10		

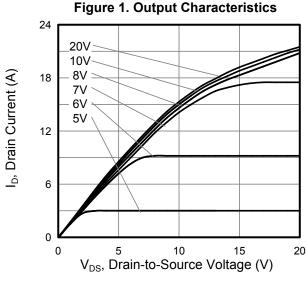


Electrical Characteristics	T _J = 25°C,	unless otherwise noted					
Demonster			Value				
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static Characteristics		·					
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0V, I _D = 250µA	650			V	
		V_{DS} = 650V, V_{GS} = 0V, T_{J} = 25°C			1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 650V, V _{GS} = 0V, T _J = 150°C		100	μA		
Gate-Source Leakage Current	I _{GSS}	$V_{GS} = \pm 30V$			±100	nA	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2.5		4.0	V	
Drain-Source On-State-Resistance	R _{DS(on)}	V _{GS} = 10V, I _D = 2.5A		0.69	0.75	Ω	
Dynamic Characteristics					•		
Input Capacitance	C _{iss}			338.7		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0V,$ $V_{DS} = 100V,$		13.9			
Reverse Transfer Capacitance	C _{rss}	f = 1.0MHz		0.66			
Total Gate Charge	Qg			9.09		nC	
Gate-Source Charge	Q _{gs}	$V_{DD} = 520V, I_D = 5A, V_{GS} = 10V$		1.46			
Gate-Drain Charge	Q _{gd}			4.48			
Turn-on Delay Time	t _{d(on)}			33.5			
Turn-on Rise Time	t _r	V _{DD} = 400V, I _D = 5A,		7.85			
Turn-off Delay Time	t _{d(off)}	$R_{G} = 25\Omega$		46.7		ns	
Turn-off Fall Time	t _f			16.35			
Drain-Source Body Diode Characte	ristics						
Body Diode Forward Voltage	V_{SD}	$T_{J} = 25^{\circ}C, I_{SD} = 5A, V_{GS} = 0V$		0.9	1.2	V	
Reverse Recovery Time	t _{rr}			208.6		ns	
Reverse Recovery Charge	Q _{rr}	V _R = 400V, I _S = 2.5A, di _F /dt = 100A/µs		1.39		μC	
Peak Reverse Recovery Current	I _{rrm}			12.5		А	

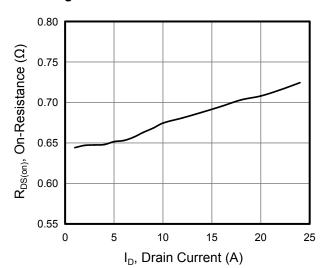
Notes

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. I_{AS} = 2A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25°C
- 3. Identical low side and high side switch with identical ${\sf R}_{\sf G}$

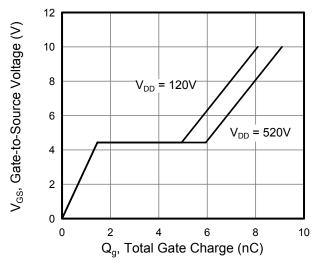
Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted

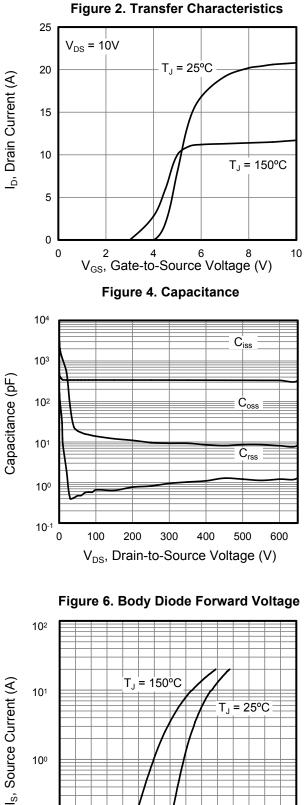


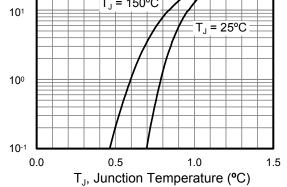












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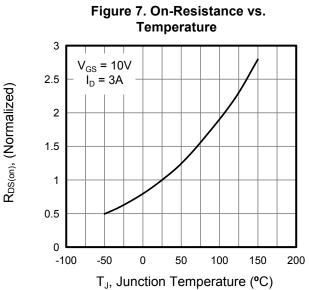


Figure9 . Transient Thermal Impedance For TO-252

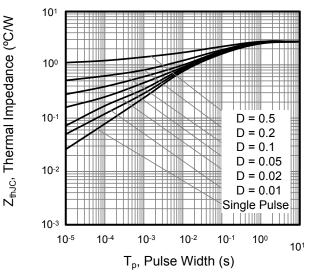


Figure 11. Typ. Coss Stored Energy

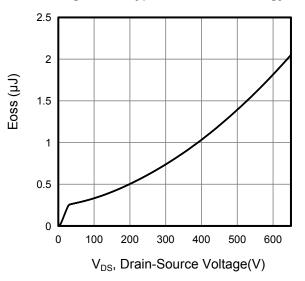


Figure 8. Breakdown voltage

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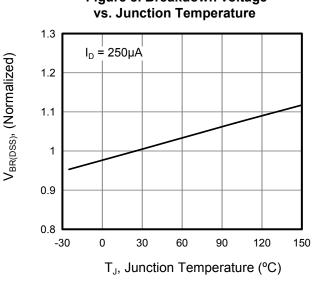
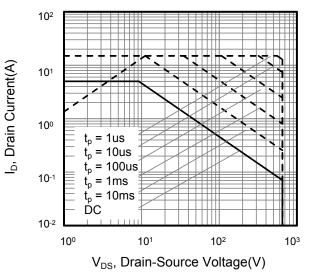


Figure 10. Safe Operation Area For TO-252





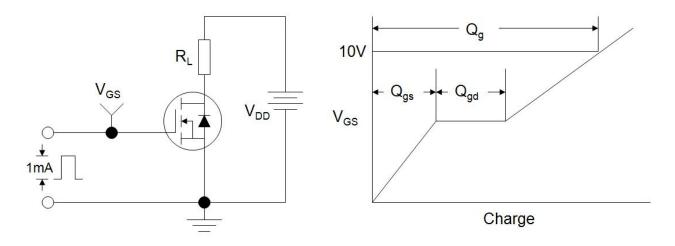


Figure B: Resistive Switching Test Circuit and Waveform

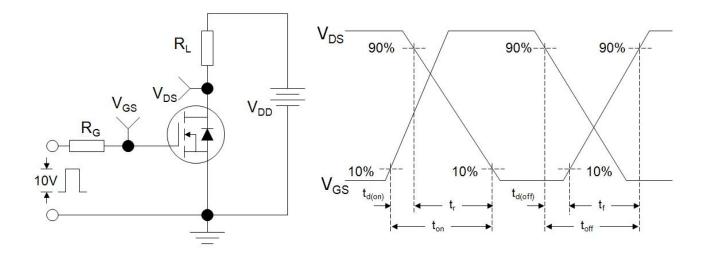
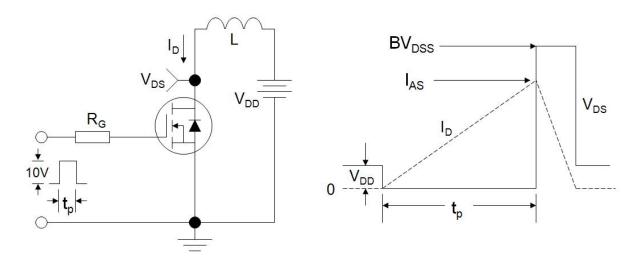


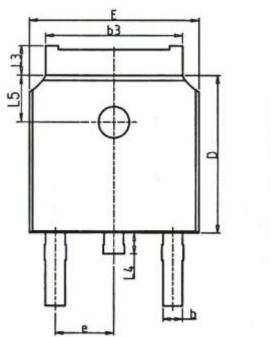
Figure C: Unclamped Inductive Switching Test Circuit and Waveform

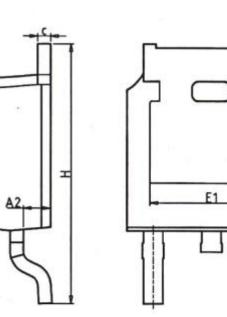


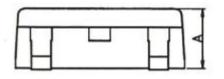
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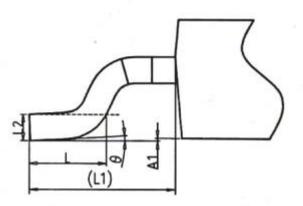


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Unit:mm						
Symbol	Min.	Nom	Max.			
А	2.20	2.30	2.38			
A1	0.00	-	0.20			
A2	0.97 1.07		1.17			
b	0.68	0.78	0.90			
b3	5.20	5.33	5.46			
с	0.43	0.53	0.61			
D	5.98 6.10		6.22			
D1	5.30 REF					
E	6.40	6.60	6.73			
E1	4.63 -		-			

Unit:mm					
Symbol	Min.	Max.			
е		2.286 BSC			
н	9.40	10.10	10.50		
L	1.38	1.50	1.75		
L1	2.90 REF				
L2	0.51 BSC				
L3	0.88	-	1.28		
L4	0.50	-	1.00		
L5	1.65	1.80	1.95		
θ	0°	-	8°		

TO-252(封装厂H)



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